	User Name & ID (Print):	
PI (subject to change):		User Signature & Date:
Research Focus (subject to change):		User e-mail:

	Process Name	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials
	Acetic Acid, Glacial								
	Ammonium Fluoride								
	Ammonium Hydroxide								
	Aqua Regia								
	Buffered Oxide Etch								
	HNA								
	Hydrochloric Acid (HCl)								
SIS	Hydrofluoric Acid (HF)								
Hazards	Hydrogen Peroxide								
	Nitric Acid								
Extreme	PAN								
ctre	Phosphoric Acid								
Û	Piranha								
	Potassium Hydroxide								
	RCA1 (Base)								
	RCA2 (Acid)								
	SulphoNitric								
	Sulphuric Acid								

Process Name	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials
Breadth of Hazards								
Haz Waste Management								
Haz Waste Management Labeling Experiments Pouring and Mixing								
Pouring and Mixing								
PPE Choice & Cleaning								
Sharps								
Work Station Use								
Work Station Use KOH Bath RCA Bath Sonicators Stir- and Hotplates								
RCA Bath								
Sonicators								
Stir- and Hotplates								

Users: By initialing, you agree that you understand and will follow the SOP.

If you forget any rules it is your responsibility to seek help from the lab staff, who will happily provide further trainin

User Name & ID (Print):

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Process Name	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials	
Alcatel DRIE									
Cannon Aligner									
CHA E-beam Evaporator									
CHA Sputterer									
CPD									
Dektak 3030 and/or 2A									
Dicing Saw									
EVG Aligner									
FEI NanoSEM									
FirstNano Nanowire CVD									
Karl Suss MA-4									
Lesker Sputter Mann PG									
Mann PG									
MRL Furnace									
Nanonex									
PlasmaTherm Etcher									
RTP									
Solitec Spinner/Hotplate									
Spin Rinsers									
Technics PECVD									
Technics RIE									
UV Flood									

	Process Name	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials	Date	User Initials	Qualifier Initials
	Aqueous Developers								
	Chrome Etch								
ards	DMSO								
Hazards	EBL Developer								
Lesser	Halogenated Solvents								
	Monolayer Deposition								
	PR Diluents & Strippers								
Jmc	Squirt Bottle Solvents								
Common	Standard Photoresists								
)									
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Date

Date	

Date

Date